

CERTIFICATE OF	Docket No.									
Applicant(s): Makoto TERUI et al. OK0.597										
Serial No. 10/717,934	Filing Date 11/21/2003	Examiner TBA	Group Art Unit 2812							
Invention: METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE HAVING A HEAT SPREADING LAYER										
I hereby certify that this	REQUEST	FOR CORRECTED FILING R	ECEIPT							
•	*****	(Identify type of correspondence)	- 500 547 0105							
is being tacsimile transm	itted to the United States Patent	and Trademark Office (Fax. N	0. 703-746-9195							
on APRIL 29,	, 2004									
(Date)										
	(Typed or Frinted Djame of Person Signing Certificate) (Signature)									
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

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Makoto TERUI et al.

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Serial No. 10/717,934

Group Art Unit 2812

Filed: November 21, 2003

METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE HAVING A HEAT SPREADING LAYER

REQUEST FOR CORRECTED FILING RECEIPT

Official of Initial Patent Examination's Filing Receipt Corrections Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Attached is a copy of the official filing receipt from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested.

Please correct the following data as follows:

Please change the first Applicant's name as follows:

Makoto TERUI

Respectfully submitted,

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Dated: April 29, 2004



United States Patent and Trademark Office

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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/717,934	11/21/2003	2812	0.00	OKI.597	19	18	4

CONFIRMATION NO. 7542

VOLENTINE FRANCOS, P.L.L.C. Suite 150 12200 Sunrise Valley Drive Reston, VA 20191 VOLENTINE FRANCOS NOCCO000000 12046832*

MAR 0 9 2004

Date Mailed: 03/08/2004

Receipt is acknowledged of this regular Pateur policies in the considered in its order and you will be notified as to the results of the examination. Belsufe to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filling Receipt, please write to the Office of Initial Patent Examination's Filling Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filling Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filling Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filling Receipt Incorporating the requested corrections (if appropriate).

Applicant(s)

Makoto Teni

Terui Mekoto, Residence Not Provided; Yasuo Tanaka, Residence Not Provided; Takashi Noguchi, Residence Not Provided;

Domestic Priority data as claimed by applicant

Foreign Applications

JAPAN 2002-339332 11/22/2002

If Required, Foreign Filing License Granted: 03/08/2004

Projected Publication Date: To Be Determined - pending completion of Missing Parts

Non-Publication Request: No

Early Publication Request: No

Title

Method for fabricating a semiconductor device having a heat spreading layer

Preliminary Class

438

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